

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	33	colloidal with metal with porous with substrate	US-PGPUB; USPAT	OR	ON	2007/09/06 16:09
S2	5065	colloidal with metal with solution	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:10
S3	181	S2 and film and (porous with substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:31
S4	4257	metal adj (colloid\$2 or sol)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:34
S5	0	S4 and (conductive adj film) and (porous adj substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:32
S6	8	S4 and (conductive adj film) and (porous with substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:32
S7	226	S4 and (porous with substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/06 16:34

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S8	48674	porous with substrate	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:57
S9	218	S8 and (colloid\$3 adj metal)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:57
S10	58	S9 and (conduct\$3 with (film or layer))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:58
S11	14039	porous adj substrate	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:57
S12	56	S11 and (colloid\$3 adj metal)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:57
S13	10	S12 and (conduct\$3 with (film or layer))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/08 16:58
S14	250	(organic with semiconductor) and (porous with electrode)	USPAT	OR	ON	2007/09/08 17:33
S15	26	(organic with semiconductor) and (porous adj electrode)	USPAT	OR	ON	2007/09/08 17:33